XP134A11A1SR



ETR1114 001a

Power MOSFET

■GENERAL DESCRIPTION

The XP134A11A1SR is a P-channel Power MOSFET with low on-state resistance and ultra high-speed switching characteristics

Two FET devices are built into the one package.

Because high-speed switching is possible, the IC can be efficiently set thereby saving energy.

The small SOP-8 package makes high density mounting possible.

■APPLICATIONS

- ●Notebook PCs
- Cellular and portable phones
- On-board power supplies
- Li-ion battery systems

■FEATURES

Low On-State Resistance :Rds(on)= 0.065Ω (Vgs=-10V)

:Rds(on)=0.11 Ω (Vgs=-4.5V)

Ultra High-Speed Switching

Driving Voltage : -4.5V

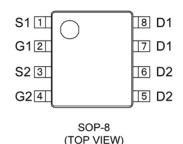
P-Channel Power MOSFET

DMOS Structure

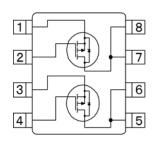
Two FET Devices Built-in

Package : SOP-8

■PIN CONFIGURATION



■EQUIVALENT CIRCUIT



P-channel MOSFET (2 devices built-in)

■ PIN ASSIGNMENT

PIN NUMBER	PIN NAME	FUNCTION
1	S1	Source
2	G1	Gate
3	S2	Source
4	G2	Gate
5~6	D2	Drain
7~8	D1	Drain

■ ABSOLUTE MAXIMUM RATINGS

Ta = 25°C

	1a - 23 C					
PARAMETER	SYMBOL	RATINGS	UNITS			
Drain-Source Voltage	Vdss	-30	>			
Gate-Source Voltage	Vgss	±20	>			
Drain Current (DC)	ld	-4	Α			
Drain Current (Pulse)	ldp	-16	Α			
Reverse Drain Current	ldr	-4	Α			
Channel Power Dissipation *	Pd	2	W			
Channel Temperature	Tch	150	ပွ			
Storage Temperature Range	Tstg	-55~150	သိ			

^{*} When implemented on a glass epoxy PCB

■ELECTRICAL CHARACTERISTICS

DC Characteristics Ta = 25°C

PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Drain Cut-Off Current	ldss	Vds=-30V, Vgs=0V	-	-	-10	μΑ
Gate-Source Leak Current	lgss	Vgs=±20V, Vds=0V	-	-	±1	μΑ
Gate-Source Cut-Off Voltage	Vgs(off)	ld=-1mA, Vds=-10V	-1.0	-	-2.5	V
Drain-Source On-State Resistance *	Ddo(an)	Id=-2A, Vgs=-10V	-	0.055	0.065	Ω
Dialii-Source Oil-State Resistance	Rds(on)	Id=-2A, Vgs=-4.5V	-	0.09	0.11	Ω
Forward Transfer Admittance *	Yfs	Id=-2A, Vds=-10V	-	5	-	S
Body Drain Diode Forward Voltage	Vf	If=-4A, Vgs=0V	-	-0.85	-1.1	V

^{*}Effective during pulse test.

Dynamic Characteristics

Ta = 25°C

PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Input Capacitance	Ciss	Vds=-10V, Vgs=0V f=1MHz	-	680	-	pF
Output Capacitance	Coss		-	450	-	pF
Feedback Capacitance	Crss		ı	170	ı	pF

Switching Characteristics

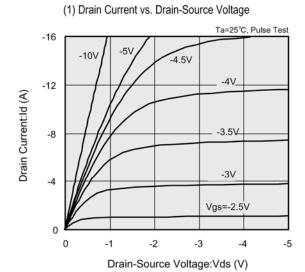
Ta = 25°C

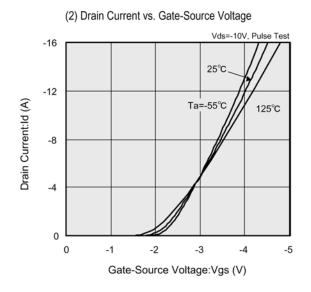
PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Turn-On Delay Time	td (on)	Vgs=-5V, Id=-2A Vdd=-10V	-	15	-	ns
Rise Time	tr		-	20	-	ns
Turn-Off Delay Time	td (off)		-	30	-	ns
Fall Time	tf		-	20	-	ns

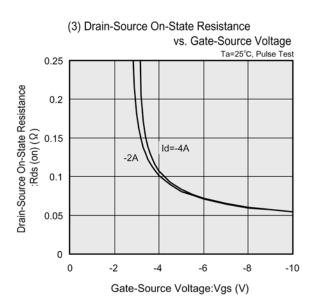
Thermal Characteristics

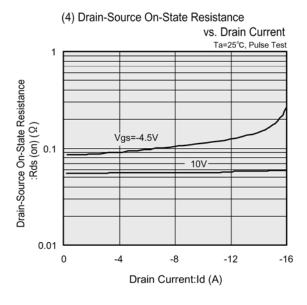
PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Thermal Resistance (Channel-Ambience)	Rth (ch-a)	Implement on a glass epoxy resin PCB	-	62.5	-	°C/W

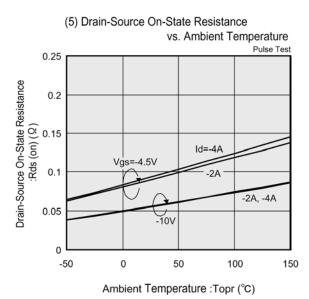
■TYPICAL PERFORMANCE CHARACTERISTICS

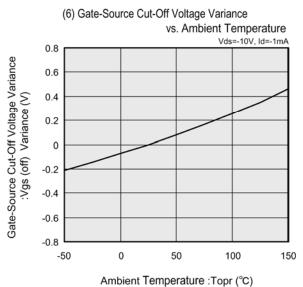




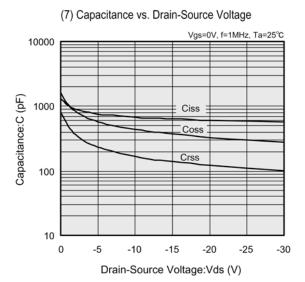


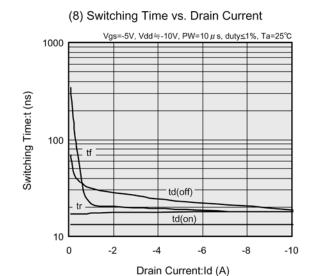


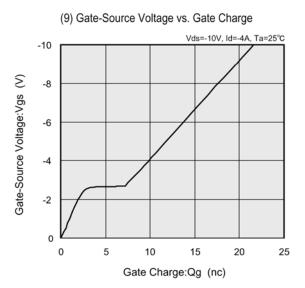


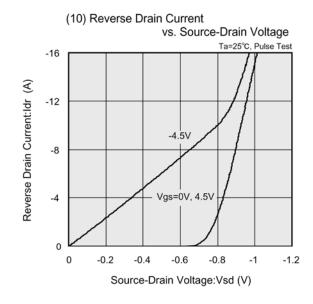


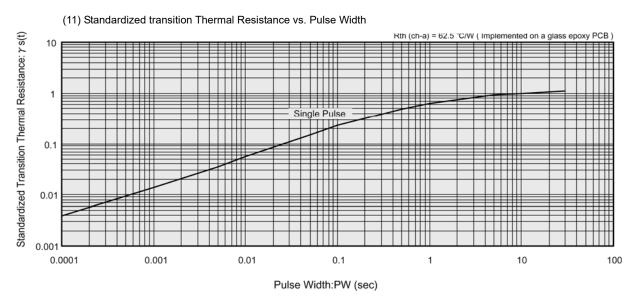
■TYPICAL PERFORMANCE CHARACTERISTICS (Continued)











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